N-Channel Enhancement-Mode Vertical DMOS FETs

Ordering Information

BV_{DSS} / BV_{DGS}	$R_{DS(ON)}$ (max)	$V_{GS(th)}$ (max)	Order Number / Package	
			TO-236AB*	Die
15V	7.0Ω	1.0V	TN2101K1	TN2101ND

*Same as SOT-23. All units shipped on 3,000 piece carrier tape reels.

Product marking for SOT-23:

N1U✳

where ✳ = 2-week alpha date code

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Features

- ☐ Free from secondary breakdown
- ☐ Low power drive requirement
- ☐ Ease of paralleling
- ☐ Low C_{ISS} and fast switching speeds
- ☐ Excellent thermal stability
- ☐ Integral Source-Drain diode
- ☐ High input impedance and high gain
- ☐ Complementary N- and P-channel devices

Applications

- ☐ Logic level interfaces – ideal for TTL and CMOS
- ☐ Solid state relays
- ☐ Battery operated systems
- ☐ Photo voltaic drives
- ☐ Analog switches
- ☐ General purpose line drivers
- ☐ Telecom switches

Absolute Maximum Ratings

Drain-to-Source Voltage	BV_{DSS}
Drain-to-Gate Voltage	BV_{DGS}
Gate-to-Source Voltage	±15V
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

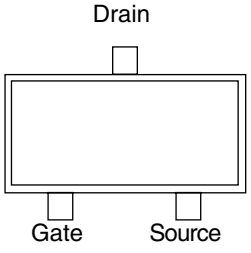
* Distance of 1.6 mm from case for 10 seconds.

Advanced DMOS Technology

These enhancement-mode (normally-off) transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Package Options



TO-236AB
(SOT-23)
top view

Note: See Package Outline section for dimensions.

Thermal Characteristics

Package	I_D (continuous)*	I_D (pulsed)	Power Dissipation @ T_A = 25°C	θ_{jc} °C/W	θ_{ja} °C/W	I_{DR}*	I_{DRM}
TO-236AB	0.17A	0.8A	0.36W	200	350	0.17A	0.8A

* I_D (continuous) is limited by max rated T_j.

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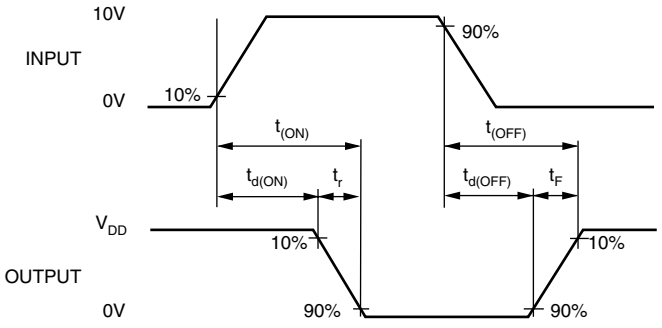
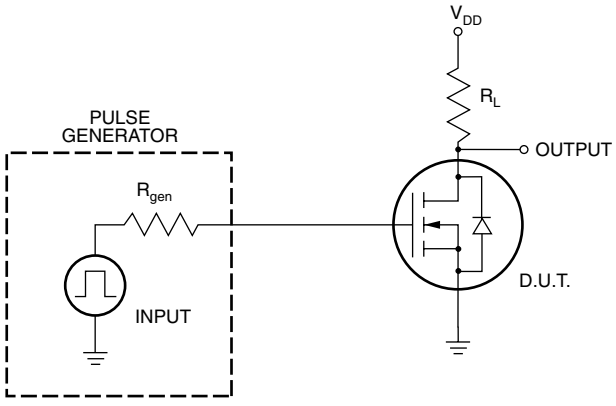
Electrical Characteristics (@ 25°C unless otherwise specified)

Symbol	Parameter	Min	Typ	Max	Unit	Conditions
BV_{DSS}	Drain-to-Source Breakdown Voltage	15			V	I_D = 1mA, V_{GS} = 0V
$V_{GS(th)}$	Gate Threshold Voltage	0.5		1.0	V	V_{GS} = V_{DS}, I_D = 1mA
$\Delta V_{GS(th)}$	Change in $V_{GS(th)}$ with Temperature			-5.5	mV/°C	I_D = 1mA, V_{GS} = V_{DS}
I_{GSS}	Gate Body Leakage			100	nA	V_{GS} = ±15V, V_{DS} = 0V
I_{DSS}	Zero Gate Voltage Drain Current			10	µA	V_{GS} = 0V, V_{DS} = Max Rating
				1.0	mA	V_{GS} = 0V, V_{DS} = 0.8 Max Rating T_A = 125°C
$I_{D(ON)}$	ON-State Drain Current	60			mA	V_{GS} = 3.0, V_{DS} = 15V
$R_{DS(ON)}$	Static Drain-to-Source ON-State Resistance			50	Ω	V_{GS} =1.2V, I_D = 2.0mA
				7.0	Ω	V_{GS} = 3V, I_D = 50mA
$\Delta R_{DS(ON)}$	Change in $R_{DS(ON)}$ with Temperature			0.75	%/°C	I_D = 50mA, V_{GS} = 3V
G_{FS}	Forward Transconductance	50			m℧	V_{DS} = 3V, I_D = 50mA
C_{ISS}	Input Capacitance			110	pF	V_{GS} = 0V, V_{DS} = 15V, f = 1MHz
C_{OSS}	Common Source Output Capacitance			60		
C_{RSS}	Reverse Transfer Capacitance			35		
$t_{d(ON)}$	Turn-ON Delay Time			5	ns	V_{DD} = 15V I_D = 50mA R_{GEN} = 25Ω
t_r	Rise Time			15		
$t_{d(OFF)}$	Turn-OFF Delay Time			15		
t_f	Fall Time			25		
V_{SD}	Diode Forward Voltage Drop			1.8	V	I_{SD} = 50mA, V_{GS} = 0V
t_{rr}	Reverse Recovery Time		100		ns	I_{SD} = 50mA, V_{GS} = 0V

Notes:
1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)
2. All A.C. parameters sample tested.

Switching Waveforms and Test Circuit





Typical Performance Curves

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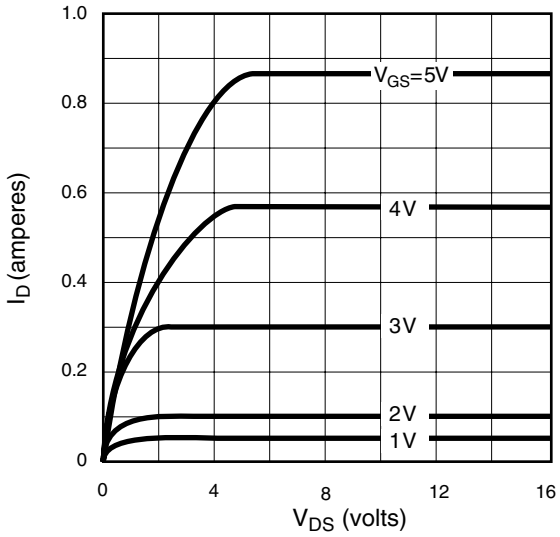
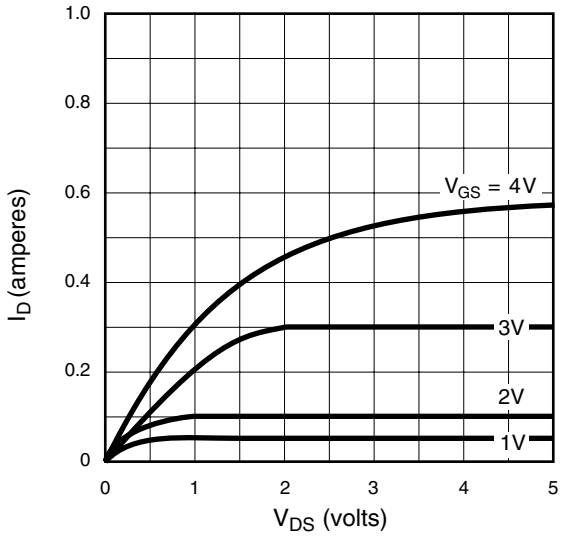
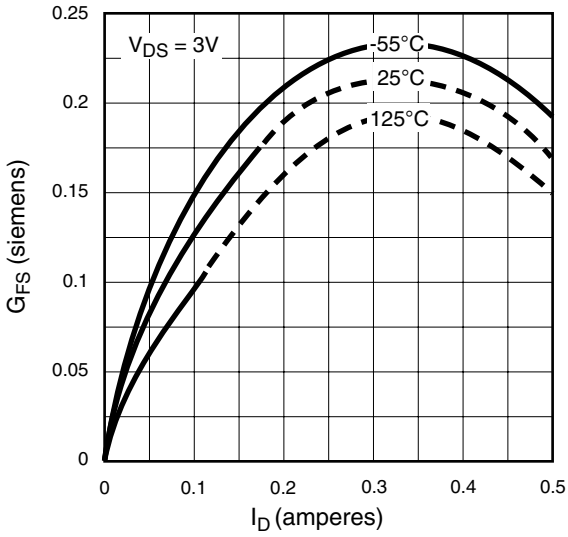
Output Characteristics



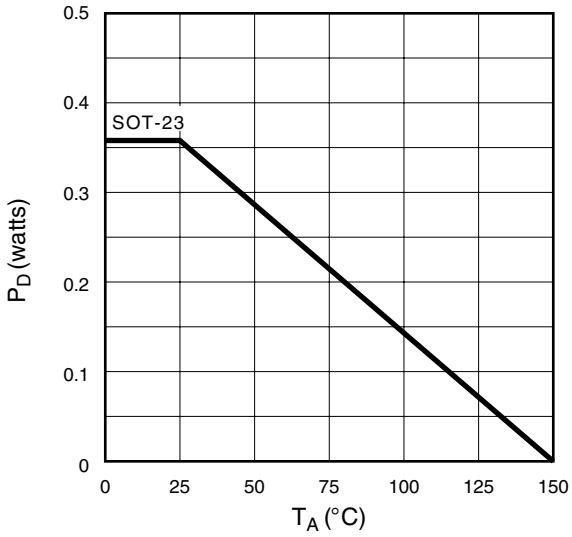
Saturation Characteristics



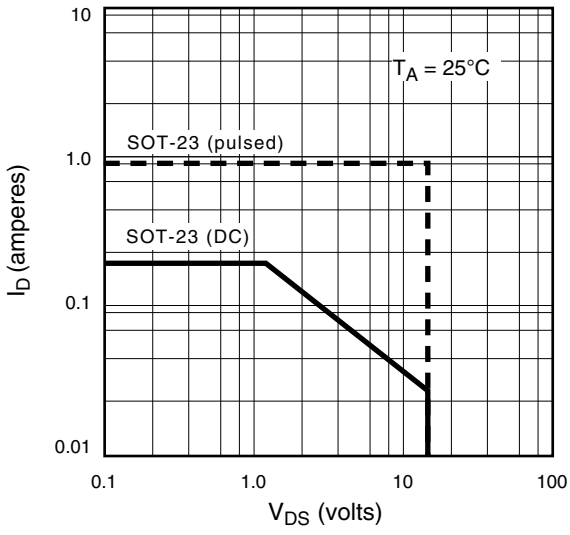
Transconductance vs. Drain Current



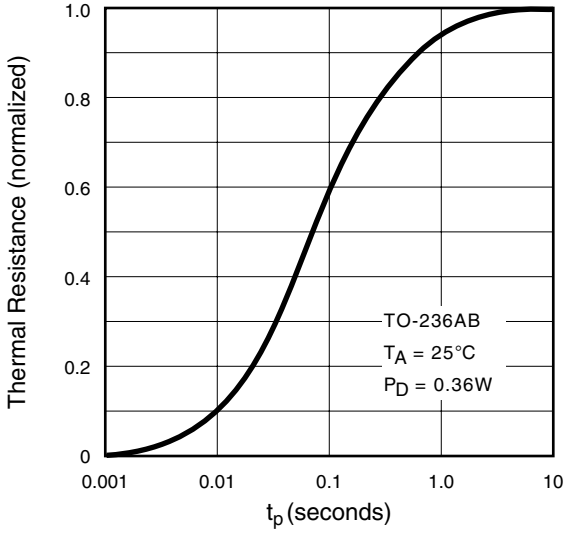
Power Dissipation vs. Temperature



Maximum Rated Safe Operating Area



Thermal Response Characteristics



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Typical Performance Curves

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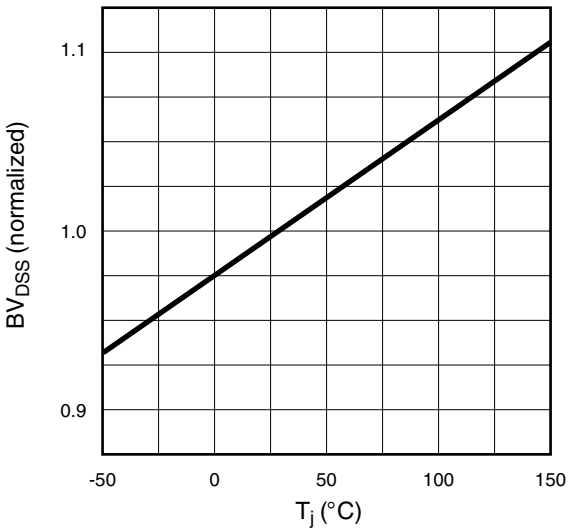
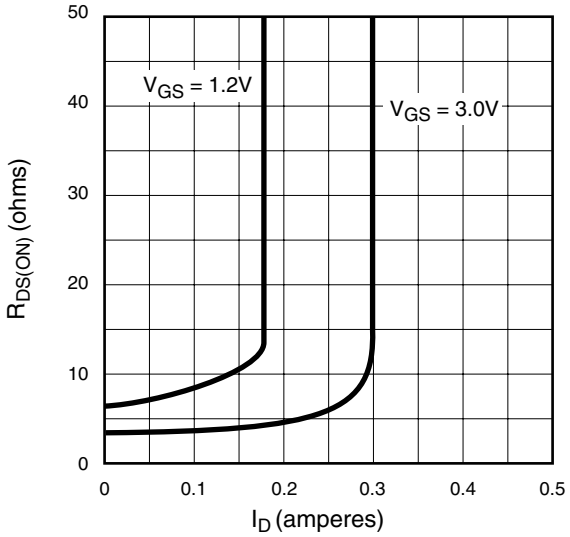
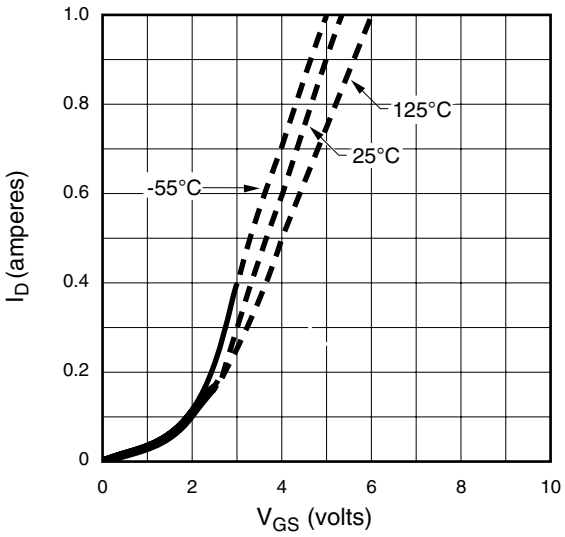
BV$_{DSS}$ Variation with Temperature



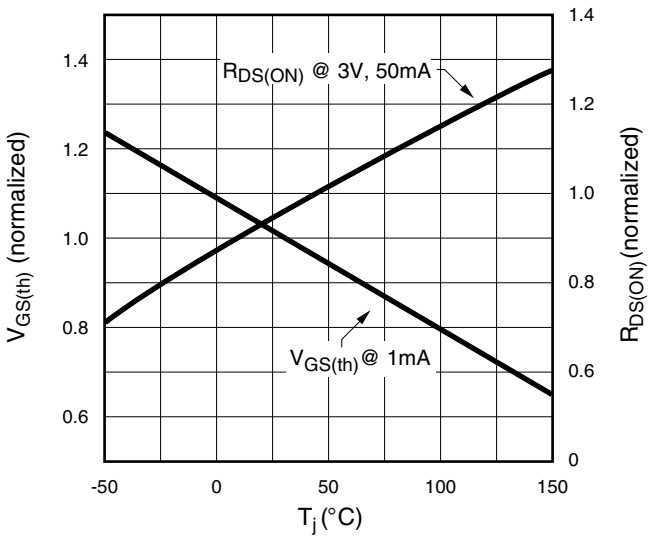
On-Resistance vs. Drain Current



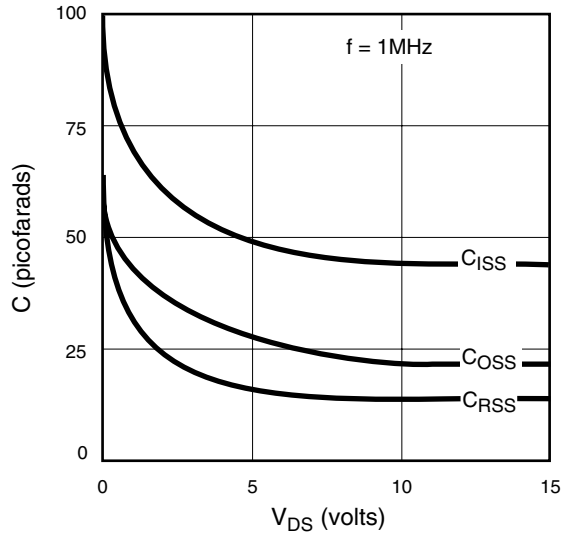
Transfer Characteristics



V$_{TH}$ and R$_{DS}$ Variation with Temperature



Capacitance vs. Drain-to-Source Voltage



Gate Drive Dynamic Characteristics